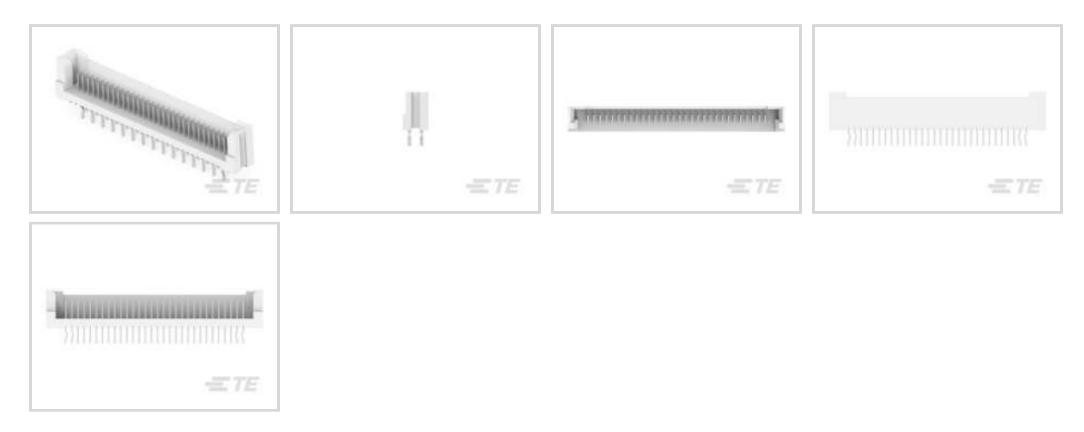
# 3-917361-0 - ACTIVE

### AMPMODU | AMPMODU 2 mm

TE Internal #: 3-917361-0 PCB Mount Header, Vertical, Board-to-Board, 30 Position, 1.25 mm [.049 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU 2 mm

### View on TE.com >

### Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 30

Number of Rows: 1

### Features

**E T E connectivity** 

### **Product Type Features**

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Partially Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
PCB Mount Orientation	Vertical
Number of Positions	30
Number of Rows	1
Board-to-Board Configuration	Parallel
Electrical Characteristics	
Insulation Resistance	100 MΩ
Operating Voltage	50 VAC
Body Features	

**C** For support call+1 800 522 6752

PCB Mount Header, Vertical, Board-to-Board, 30 Position, 1.25 mm [.049 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU 2 mm



Primary Product Color	White
Contact Features	
Contact Layout	Inline
Mating Tab Width	1.6 mm[.063 in]
Mating Tab Thickness	.25 mm[.01 in]
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Tin
Contact Mating Area Plating Material Thickness	.8 μm[31.5 μin]
Contact Type	Tab
Contact Current Rating (Max)	1 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.25 mm[.01 in]
Rectangular Termination Post & Tail Width	.6 mm[.024 in]
Termination Post & Tail Length	3.2 mm[.126 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
PCB Mount Retention Type	Kinked Legs
Mating Alignment	With
Mating Alignment Type	Self-Aligning (Alignment Free)
PCB Mount Retention	With
PCB Mount Alignment	With
Connector Mounting Type	Board Mount
Housing Features	
Mating Entry Location	Тор
Centerline (Pitch)	1.25 mm[.049 in]
Housing Material	Nylon 6/6 GF
Dimensions	
Connector Height	7.8 mm[.307 in]
Row-to-Row Spacing	2.5 mm[.098 in]
PCB Thickness (Recommended)	1.6 mm[.062 in]
Usage Conditions	

**C** For support call+1 800 522 6752

PCB Mount Header, Vertical, Board-to-Board, 30 Position, 1.25 mm [.049 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU 2 mm



Operation/Application	
Circuit Application	Signal
ndustry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	180
Packaging Type	Box, Tray
•	
For compliance documentation, visit the product page on TE.com>	Compliant
•	Compliant Compliant
For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU	
EU ELV Directive 2000/53/EC	Compliant

homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

Wave solder capable to 265°C

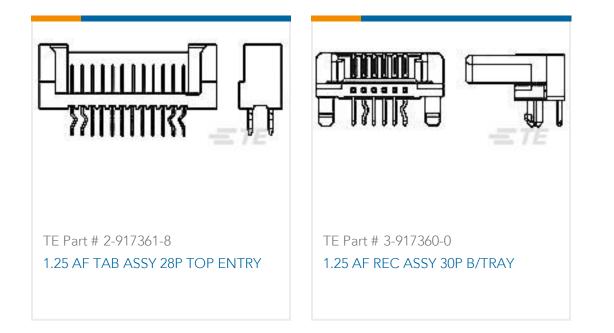
#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

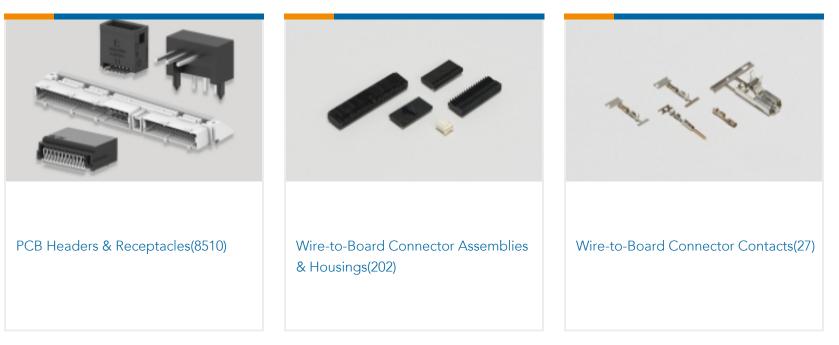
## **Compatible Parts**

PCB Mount Header, Vertical, Board-to-Board, 30 Position, 1.25 mm [.049 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU 2 mm



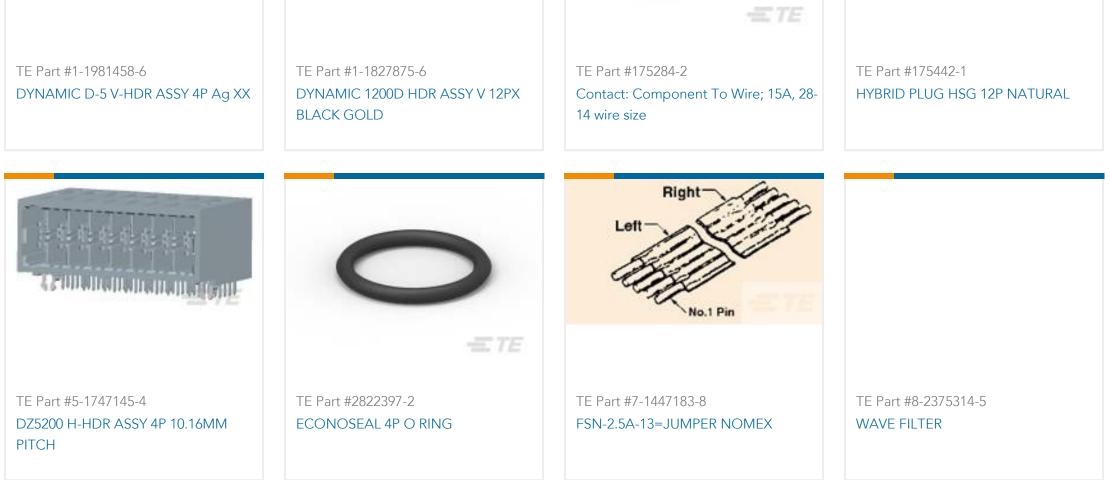


# Also in the Series AMPMODU 2 mm



# Customers Also Bought





## Documents

### Product Drawings

1.25 AF TAB ASSY 30P TOP ENTRY

English

### **CAD** Files

Customer View Model

ENG\_CVM\_CVM\_3-917361-0\_C.2d\_dxf.zip

PCB Mount Header, Vertical, Board-to-Board, 30 Position, 1.25 mm [.049 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU 2 mm



English

3D PDF

3D

Customer View Model

ENG\_CVM\_CVM\_3-917361-0\_C.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_3-917361-0\_C.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Product Specification

Japanese

Crimping Multi-Interlock Connector Contacts

Japanese

Agency Approvals Agency Approval Document

English